# U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office Docket No. ROC920050208US1

# RECORDATION FORM COVER SHEET PATENTS ONLY

To the Commissioner for Patents. Please record the attached only	ginal documents or copy thereof.
Name of conveying party(ies):	2. Name and address of receiving
Brodeky William Louis	party(les):
Brodsky, William Louis Scanlon, Michael F.	Name: International Business Machines Corporation
Torok, John G.	
Total Common	Internal Address:
Additional names of conveying party(les) attached?	
☐ yes	-
2. Matura of Conveyance	
3. Nature of Conveyance	Street Address: New Orchard Road City Armonk
	State New York Zip 10504
☐ Security Agreement ☐ Change of Name ☐ Other	
- Counci	Additional name(s) & address(es) attached?  yes  no
Execution Date: 07/28/2005; 07/27/2005; 07/27/2005	
Application number(s) or patent number(s):	
TITLE: PROVIDING MECHANICAL SUPPORT FOR IN	MODUL AR INTERCONNECT SYSTEMS
If this document is being filed together with a new application, the	execution date of the application is
A. Patent Application No(s).	Patent No(s).
Serial No. 11/193,822	
Docket No. ROC920050208US1	
Ì	
Additional numbers attac	ched? 🔲 Yes 🛛 No
Name and address of party to whom correspondence	C Tatal and the set of
concerning document should be mailed:	Total number of applications and patents involved:
Leslie J. Payne, Attorney	7. Total fee (37 CFR 3.41): \$ 40.00
IBM Corporation - Dept. 917	☐ Enclosed
3605 Highway 52 North	
Rochester, MN 55901-7829	☐ Authorized to be charged to deposit account     ☐ Total fee due
	✓ Any deficiencies in the enclosed fees
	8. Deposit account number:
	09-0465
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Statement and signature	
To the best of my knowledge and belief, the foregoing information is to	tile And forward and any attached service at
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Locio I Brupo Bos No 25 270	$\mathscr{O}$ .
Name of Person Signing  Signature  Signature	August 10, 2005  Date
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**PATENT REEL: 016626 FRAME: 0718** 

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## ASSIGNMENT

	TEO DI GIVINI LIVI			
Whereas, we				
	William Louis Brodsky , City of Binghamton	<u></u>		
	County of Broome and State of New York,			
	Michael F. Scanlon , City of Poughkeepsie			
	County of <u>Dutchess</u> and State of <u>New York</u>	_, and		
	John G. Torok , City of Poughkeepsie	_,		
	County of <u>Dutchess</u> and State of <u>New York</u>	,		
have invented certain improvements in				
PROVIDING MECHANICAL SUPPORT FOR MODULAR INTERCONNECT SYSTEMS				
and have executed a United States patent application therefor on				
Date Inventor Signed Declaration	<u>fu/2 28</u> , 2005.			
Date Inventor Signed Declaration	, 2005.			
Date Inventor Signed	, 2005.			

And whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at New Orchard Road, Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Declaration

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

#### ROC920050208US1

Sign	ed		
Inventor	at Endicott, NY	William Louis Brodsky)	Inventor Signature
	on 1./ <sub>1</sub> 28 , 2005.	First Name Middle Name Las	_
Sign	ed		
Inventor	at Poughkeepsie, NY		Inventor
		(Michael F. Scanlon)	Signature
	on, 2005.	First Name Middle Name La	st Name
Sign	ed		
Inventor	at Poughkeepsie, NY		Inventor
		(John G. Torok)	Signature
	on 2005	First Name Middle Name La	st Name

ROC920050208US1

### ASSIGNMENT

Whereas, we			
	William Louis Brodsky , City of Binghamton ,		
	County of Broome and State of New York .		
	Michael F. Scanlon , City of Poughkeepsie ,		
	County of <u>Dutchess</u> and State of <u>New York</u> , and		
	John G. Torok , City of Poughkeepsie ,		
	County of <u>Dutchess</u> and State of <u>New York</u> .		
have invented certain improvements in			
PROVIDING MECHANICAL SUPPORT FOR MODULAR INTERCONNECT SYSTEMS			
and have executed a United States patent application therefor on			
Date Inventor Signed Declaration	, 2005.		
Date Inventor Signed Declaration	JULY 27, 2005.		
Date Inventor Signed	July 27, 2005.		

And whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at New Orchard Road, Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Declaration

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

#### ROC920050208US1

Signed

Inventor

at Endicott, NY

on\_\_\_\_\_, 2005.

(William Louis Brodsky) Inventor
Signature
First Name Middle Name Last Name

Signed

Inventor

at Poughkeepsie, NY

on 7/27, 2005.

Signed

Inventor

at Poughkeepsie, NY

on 📉 27 , 2005.

(Michael F. Scanlon)

\_Inventor Signature

First Name Middle Name Last Name

\_Inventor Signature

(Aohn G. Torok) Signature First Name Middle Name Last Name